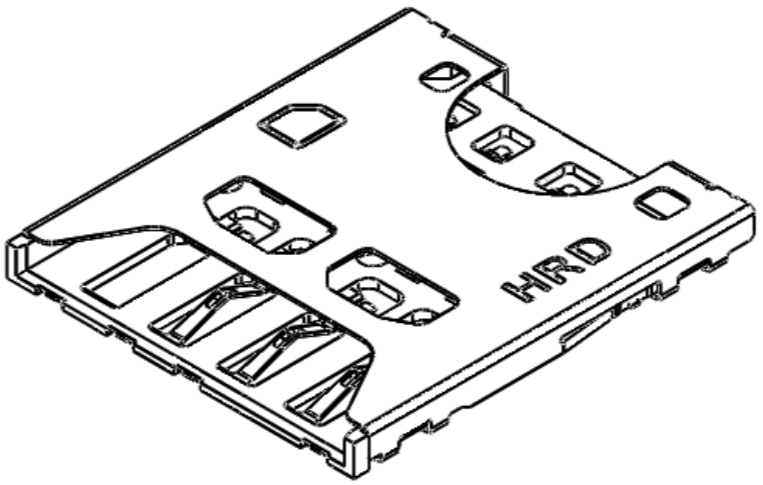


OPEN WIRE AND COPPER RESTAICTED AREA  
 1. TOUCH AREA OF CONTACT TIPS, NO ELECTRICAL FUNCTION AND ONLY FOR MECHANICAL FUNCTION  
 2. NO FIRST PCB-LAYOUT CIRCUITS IN THE AREA  
 P. C. B LAYOUT (TOLERANCE: ±0.05)

SIM CARD PIN NO.	DESCRIPTION
P1	VCC
P2	RST
P3	CLK
P5	GND
P6	VPP
P7	I/O
S/W	SWITCH PIN

- NOTES:
- MATERIAL:  
HOUSING: LCP, BLACK, UL94 V-0  
CONTACT: PHOSPHOR BRONZE, T=0.08mm  
SHELL: STAINLESS STEEL T=0.10mm
  - FINISH  
CONTACT: 50U'' MIN PLATING OVER ALL  
GOLD FLASH ON THE CONTACT AREA AND SOLDER AREA  
SHELL: GOLD FLASH IN SOLDER TAIL AREA  
30U'' NI MIN. PLATING OVER ALL
  - ALL DIMENSIONS MARKED ▼ MUST BE CONTROLLED BY QC
  - RATED PARAMETERS OF CONNECTOR  
4-1. Operating temperature: -40°C to 70°C  
4-2. Rated Current: 0.5A  
4-3. Rated Voltage: 30V DC Per Contact
  - ELECTRICAL MECHANICAL ENVIRONMENTAL  
5-1. Dielectric withstanding Voltage : 500V AC 1min.  
5-2. Insulation Resistance: 1000 MΩMin.  
5-3. Normal Force: 30g Min. Per Pin  
5-4. Durability: 1000 cycles



REV.	ECN NO.	DESCRIPTION	DATE	UNITS: mm	GENERAL TOLERANCE	DRAW:	PART NO:
				DATE: 01/16/2017	X. ±0.20 .X ±0.15 .XX ±0.10 .XXX ±0.05	X. ±2.00 .X ±1.00 .XX ±0.50	S112-1B07F13A
C	E1701015A	修改铁壳孔径	2017.01.16	SCALE: 5/1		CHECKED:	TITLE: 1.32H MICRO SIM CARD CONN.
B	E1609388A	增加方形孔	2016.09.18	SHEET: 1/1	MATERIAL:	APPROVE:	DRAWING NO:
				REV. C	FINISH: SEE NOTE		

昆山捷皇电子精密科技有限公司  
 HONGRIDA ELECTRONIC TECHNOLOGY CO., LTD.